

2N3906 / MMBT3906 / PZT3906 PNP General-Purpose Amplifier

Description

This device is designed for general-purpose amplifier and switching applications at collector currents of 10 mA to 100 mA.



Ordering Information

Part Number	Marking	Package	Packing Method	Pack Quantity
2N3906BU	2N3906	TO-92 3L	Bulk	10000
2N3906TA	2N3906	TO-92 3L	Ammo	2000
2N3906TAR	2N3906	TO-92 3L	Ammo	2000
2N3906TF	2N3906	TO-92 3L	Tape and Reel	2000
2N3906TFR	2N3906	TO-92 3L	Tape and Reel	2000
MMBT3906	2A	SOT-23 3L	Tape and Reel	3000
PZT3906	3906	SOT-223 4L	Tape and Reel	2500

April 2014

Absolute Maximum Ratings⁽¹⁾

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only. Values are at $T_A = 25^{\circ}$ C unless otherwise noted.

Symbol	Parameter	Value	Unit	
V _{CEO}	Collector-Emitter Voltage	-40	V	
V _{CBO}	Collector-Base Voltage	-40	V	
V _{EBO}	Emitter-Base Voltage	-5.0	V	
۱ _C	Collector Current - Continuous	-200	mA	
T _{J,} T _{STG}	Operating and Storage Junction Temperature Range	-55 to +150	°C	

Note:

1. These ratings are based on a maximum junction temperature of 150°C.

These are steady-state limits. Fairchild Semiconductor should be consulted on applications involving pulsed or low-duty cycle operations.

Thermal Characteristics

Values are at $T_A = 25^{\circ}C$ unless otherwise noted.

Symbol	Parameter	Maximum			Unit
		2N3906 ⁽³⁾	MMBT3906 ⁽²⁾	PZT3906 ⁽³⁾	Onit
D	Total Device Dissipation	625	350	1,000	mW
PD	Derate Above 25°C	5.0	2.8	8.0	mW/°C
R _{θJC}	Thermal Resistance, Junction to Case	83.3			°C/W
R _{θJA}	Thermal Resistance, Junction to Ambient	200	357	125	°C/W

Notes:

2. Device is mounted on FR-4 PCB 1.6 inch X 1.6 inch X 0.06 inch.

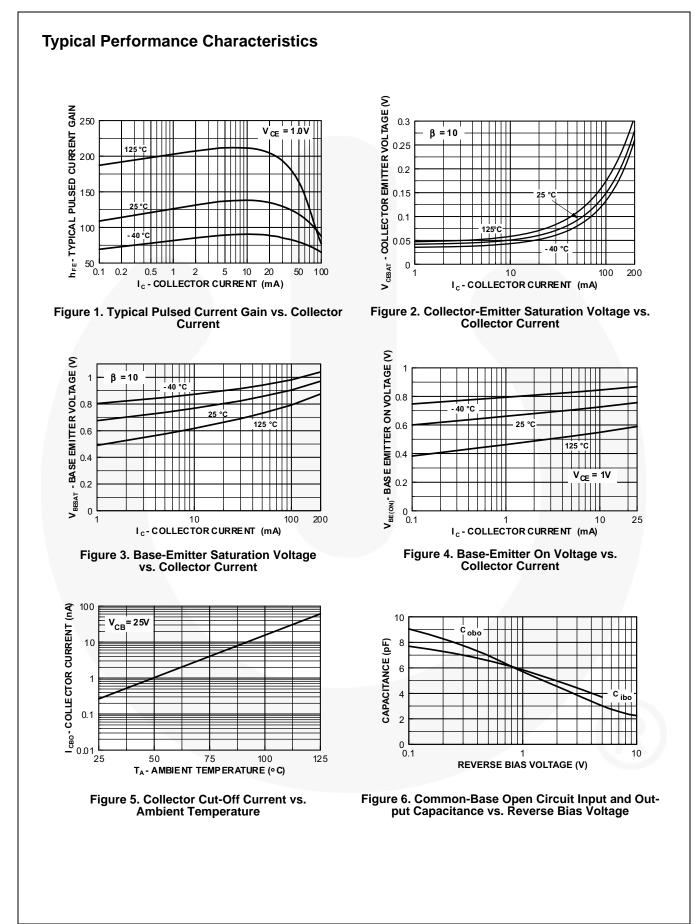
3. PCB size: FR-4, 76 mm x 114 mm x 1.57 mm (3.0 inch x 4.5 inch x 0.062 inch) with minimum land pattern size.

Values are at T_{A} = 25°C unless otherwise noted.

Symbol	Parameter	Conditions	Min.	Max.	Unit
OFF CHAR	ACTERISTICS			•	•
V _{(BR)CEO}	Collector-Emitter Breakdown Voltage ⁽⁴⁾	I _C = -1.0 mA, I _B = 0	-40		V
V _{(BR)CBO}	Collector-Base Breakdown Voltage	$I_{C} = -10 \ \mu A, \ I_{E} = 0$	-40		V
V _{(BR)EBO}	Emitter-Base Breakdown Voltage	$I_{\rm E} = -10 \ \mu A, \ I_{\rm C} = 0$	-5.0		V
I _{BL}	Base Cut-Off Current	V_{CE} = -30 V, V_{BE} = 3.0 V		-50	nA
I _{CEX}	Collector Cut-Off Current	V_{CE} = -30 V, V_{BE} = 3.0 V		-50	nA
ON CHARA	CTERISTICS				
h _{FE} [$I_{C} = -0.1 \text{ mA}, V_{CE} = -1.0 \text{ V}$	60		
		I _C = -1.0 mA, V _{CE} = -1.0 V	80		
	DC Current Gain ⁽⁴⁾	$I_{C} = -10 \text{ mA}, V_{CE} = -1.0 \text{ V}$	100	300	
		$I_{C} = -50 \text{ mA}, V_{CE} = -1.0 \text{ V}$	60		
		I _C = -100 mA, V _{CE} = -1.0V	30		
V _{CE} (sat)	Collector-Emitter Saturation Voltage	I _C = -10 mA, I _B = -1.0 mA		-0.25	- V
		I _C = -50 mA, I _B = -5.0 mA		-0.40	
) (t)	Base-Emitter Saturation Voltage	I _C = -10 mA, I _B = -1.0 mA	-0.65	-0.85	V
V _{BE} (sat)		I _C = -50 mA, I _B = -5.0 mA		-0.95	- V
SMALL SIG	NAL CHARACTERISTICS				
f _T	Current Gain - Bandwidth Product	I _C = -10 mA, V _{CE} = -20 V, f = 100 MHz	250		MHz
C _{obo}	Output Capacitance	V _{CB} = -5.0 V, I _E = 0, f = 100 kHz		4.5	pF
C _{ibo}	Input Capacitance	$V_{EB} = -0.5 \text{ V}, I_{C} = 0,$ f = 100 kHz		10.0	pF
NF	Noise Figure	I_{C} = -100 μA, V _{CE} = -5.0 V, R _S = 1.0 kΩ, f = 10 Hz to 15.7 kHz		4.0	dB
SWITCHING	CHARACTERISTICS				/
t _d	Delay Time	V _{CC} = -3.0 V, V _{BE} = -0.5 V		35	ns
t _r	Rise Time	$I_{\rm C} = -10 \text{ mA}, I_{\rm B1} = -1.0 \text{ mA}$		35	ns
t _s	Storage Time	V _{CC} = -3.0 V, I _C = -10 mA,		225	ns
t _f	Fall Time	$I_{B1} = I_{B2} = -1.0 \text{ mA}$		75	ns

Note:

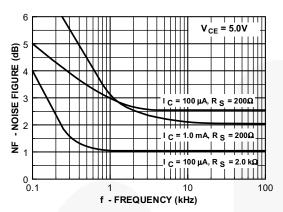
4. Pulse test: pulse width \leq 300 µs, duty cycle \leq 2.0%.



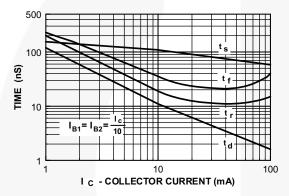
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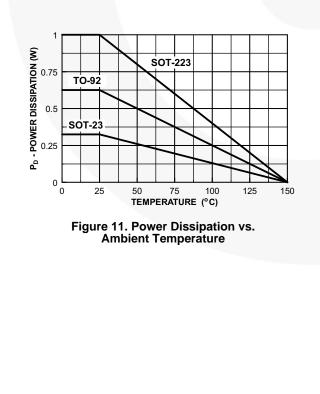
Typical Performance Characteristics (Continued)











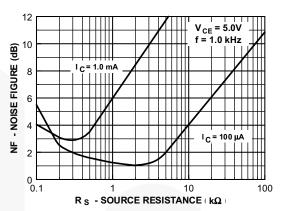
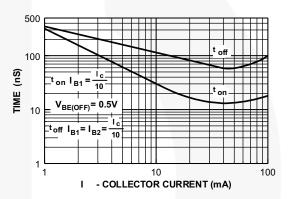
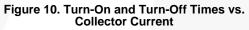
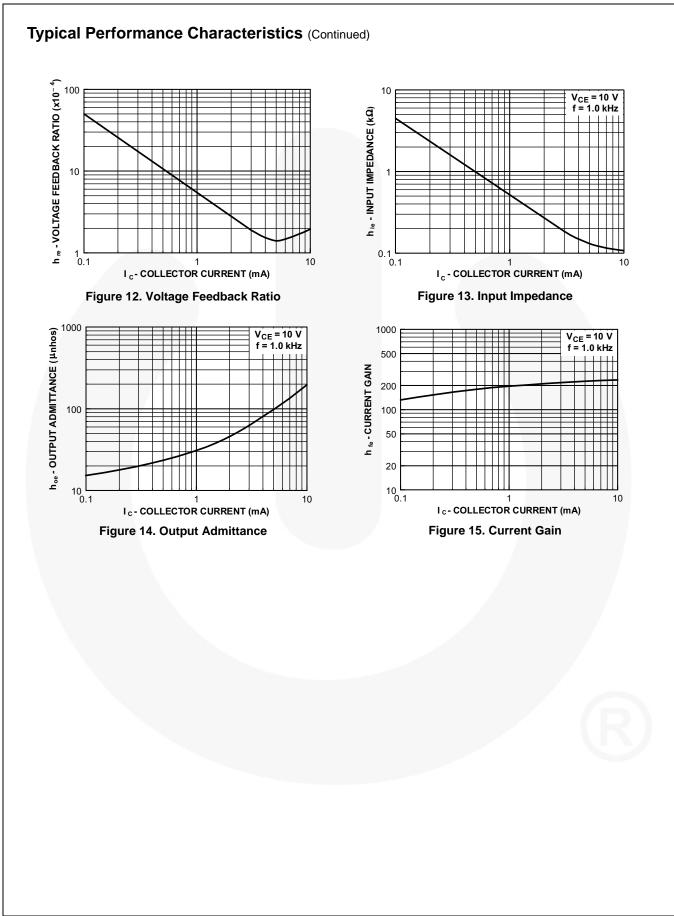


Figure 8. Noise Figure vs. Source Resistance







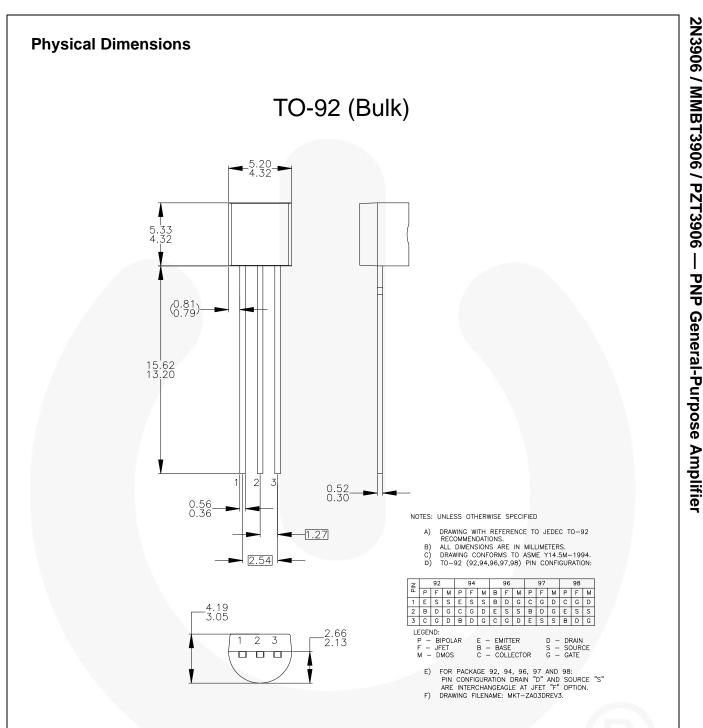
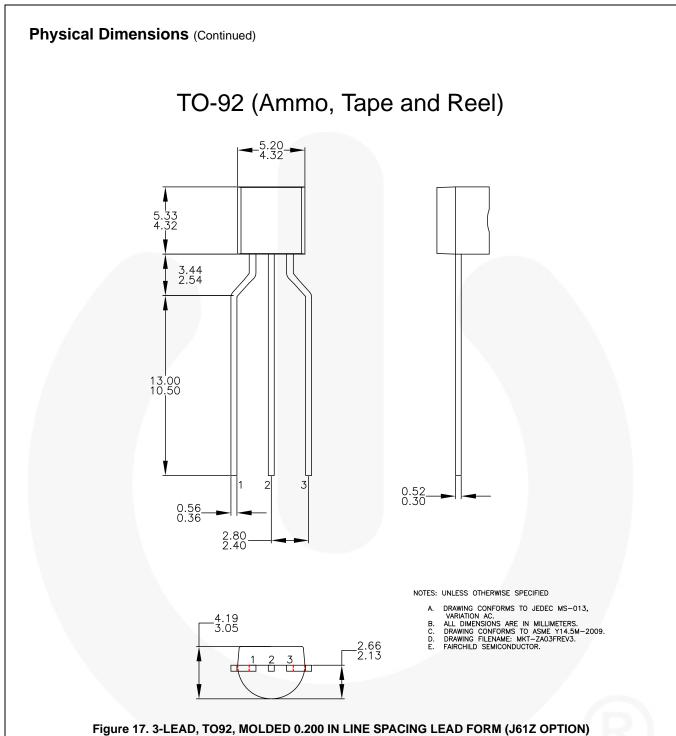


Figure 16. 3-LEAD, TO92, JEDEC TO-92 COMPLIANT STRAIGHT LEAD CONFIGURATION (OLD TO92AM3)

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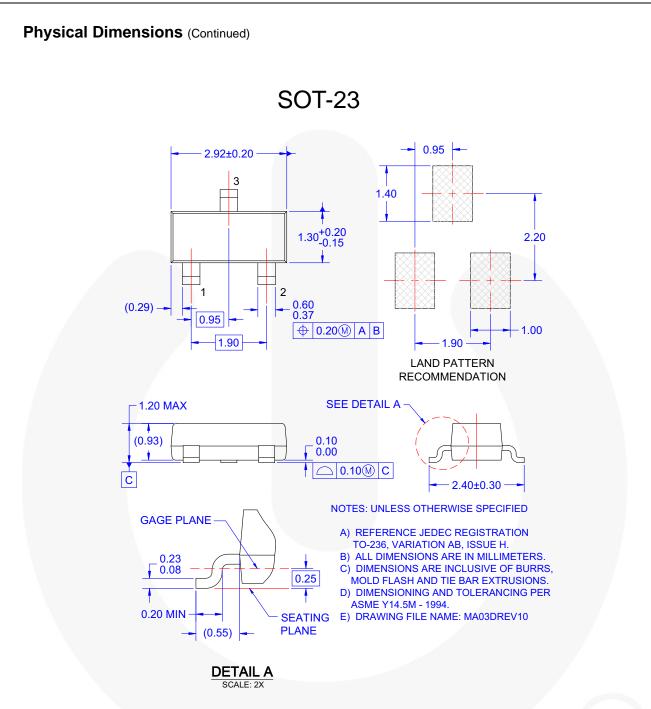


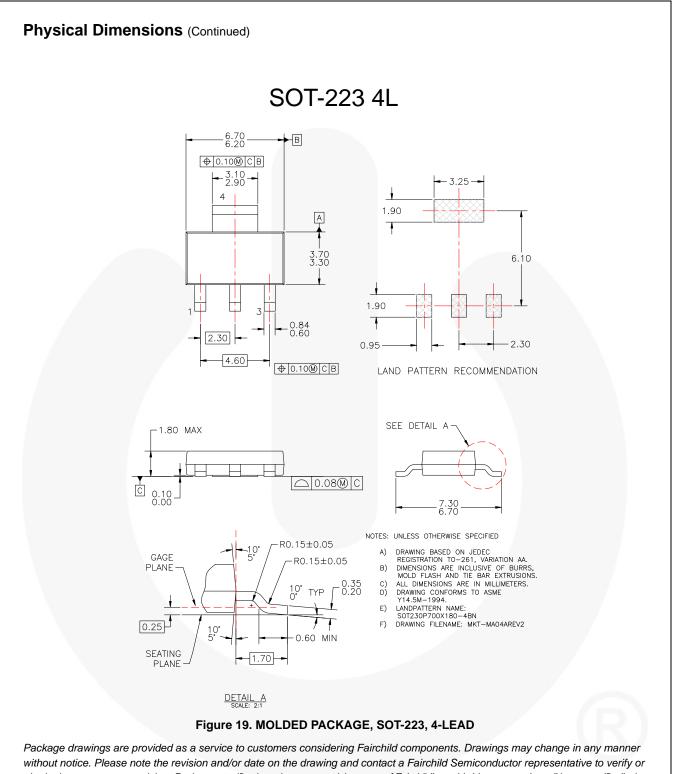
Figure 18. 3-LEAD, SOT23, JEDEC TO-236, LOW PROFILE

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